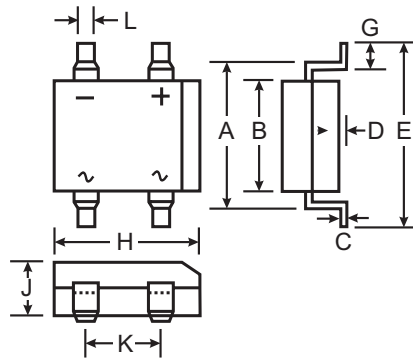


Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Surface Mount Applications
- UL Listed Under Recognized Component Index, File Number E94661
- **Lead Free Finish, RoHS Compliant (Date Code 0532+)** (Note 3)

Mechanical Data

- Case: DF-S
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish - Tin. Solder Plated Leads, Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: As Marked on Case
- Marking: Type Number, See Page 3
- Weight: 0.38 grams (approximate)



DF-S		
Dim	Min	Max
A	7.40	7.90
B	6.20	6.50
C	0.22	0.30
D	0.076	0.33
E	—	10.40
G	1.02	1.53
H	8.13	8.51
J	2.40	3.40
K	5.00	5.20
L	1.00	1.20
All Dimensions in mm		

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

Characteristic	Symbol	DF 15005S	DF 1501S	DF 1502S	DF 1504S	DF 1506S	DF 1508S	DF 1510S	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V _{RWM}								
DC Blocking Voltage	V _R								
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	580	700	V
Average Forward Rectified Current @ T _A = 40°C	I _O				1.5				A
Non-Repetitive Peak Forward Surge Current, 8.3 ms single half-sine-wave superimposed on rated load	I _{FSM}				50				A
Forward Voltage (per element) @ I _F = 1.5A	V _{FM}				1.1				V
Peak Reverse Current at rated DC blocking voltage (per element) @ T _A = 25°C @ T _A = 125°C	I _{RM}				10 500				μA
I ² t Rating for Fusing (t<8.3ms)	I ² t				10.4				A ² s
Typical Total Capacitance per element (Note 1)	C _T				25				pF
Typical Thermal Resistance, Junction to Ambient (Note 2)	R _{θJA}				40				°C/W
Operating and Storage Temperature Range	T _j , T _{STG}				-65 to +150				°C

- Notes:
1. Measured at 1.0 MHz and Applied Reverse Voltage of 4.0V DC.
 2. Thermal resistance, junction to ambient, measured on PC board with 5.0mm² (0.03mm thick) land areas.
 3. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.

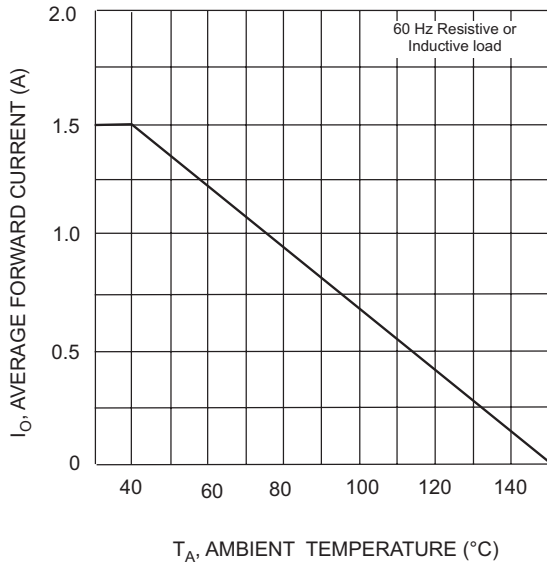


Fig. 1 Output Current Derating Curve

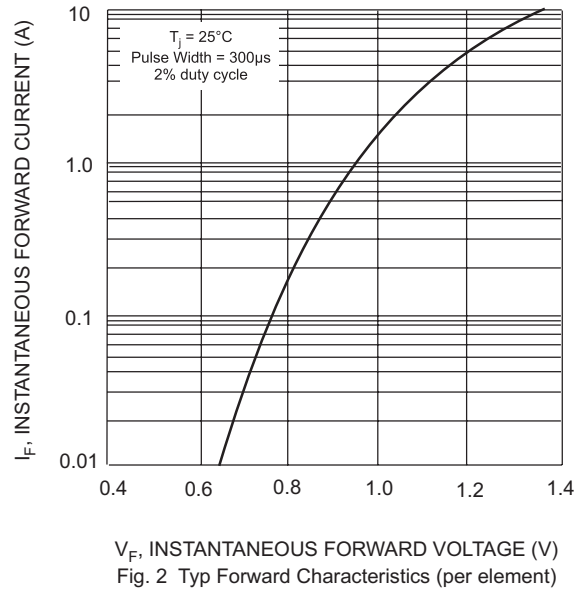


Fig. 2 Typ Forward Characteristics (per element)

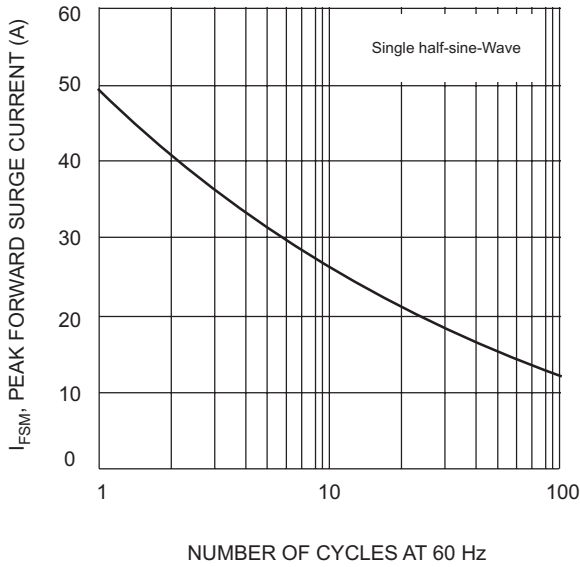


Fig. 3 Max Non-Repetitive Peak Forward Surge Current

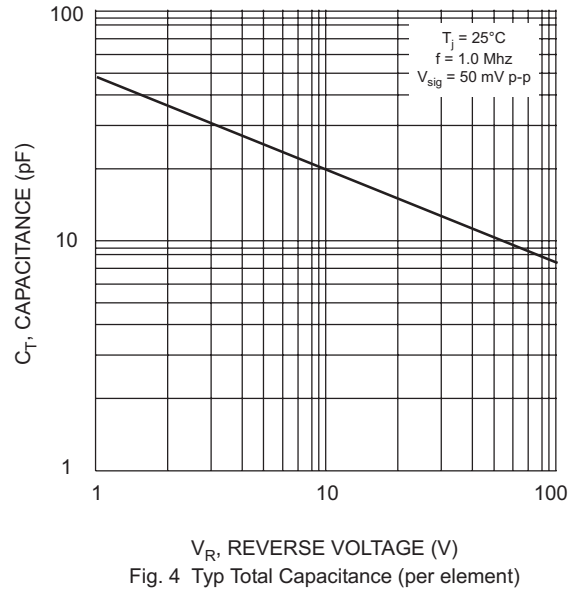


Fig. 4 Typ Total Capacitance (per element)

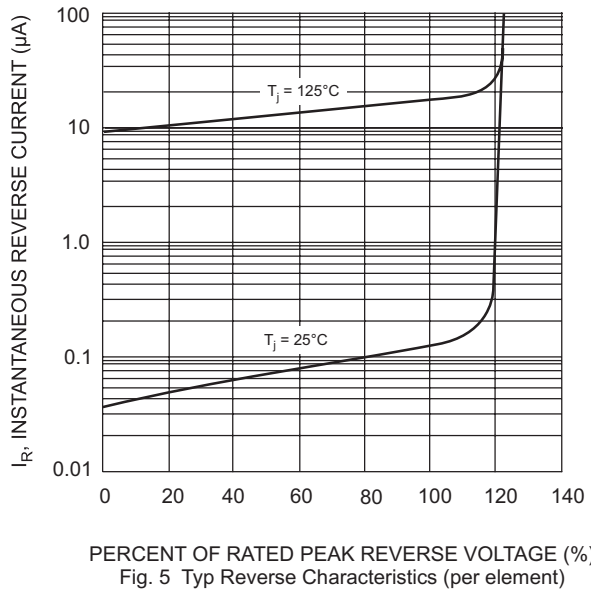


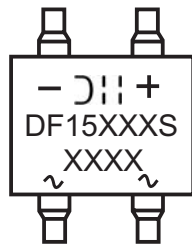
Fig. 5 Typ Reverse Characteristics (per element)

Ordering Information (Note 4)

Device	Packaging	Shipping
DF15XXXS-T	DF-S	1500/Tape & Reel
DF15XXXS	DF-S	50 per Tube

Notes: 4. For Packaging Details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



DII = Manufacturers' code marking
 DF15XXXS = Product type marking code, ex: DF1510S
 YWW = Date code marking
 Y = Last digit of year ex: 2 for 2002
 WW = Week code 01 to 52

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